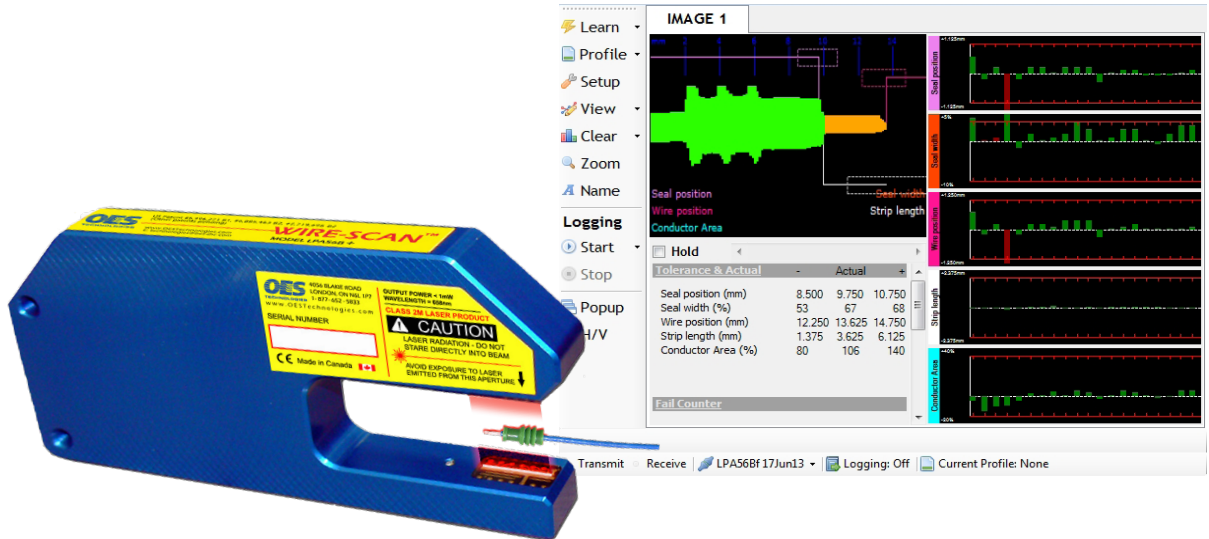


LPA56B LASER PROFILE ANALYSIS

For Strip and Seal Inspection



For Integration on Automatic Wire Processing Machines

Non-Contact

- Dynamic optical sensor inspects for wire strip and/or seal defects
- High resolution image profile captured, analyzed and compared to learned reference

Strip Inspection

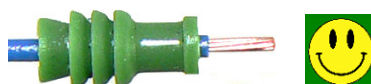
- Detects common strip defects -high/low insulation shoulder, pulled or splayed strands, and conductor mass



Pulled Strand Error

Seal Insert Inspection

- Detects common seal insertion defects – missing/re-verses/skewed seal, and seal position



Seal Position Error

WireScan Software

- Operator interface software for production, configuration and setup, and data logging

Traceability

- Data logging feature for 100% data traceability

Machine Integration

- Designed for integration onto existing and new wire processing equipment

Applications

- Automated wire processing applications requiring 100% assurance of wire strip and seal insertion quality

Patents

US 6,496,271 B1

US 6,885,463 B2

US 7,719,695 B2

WireScan

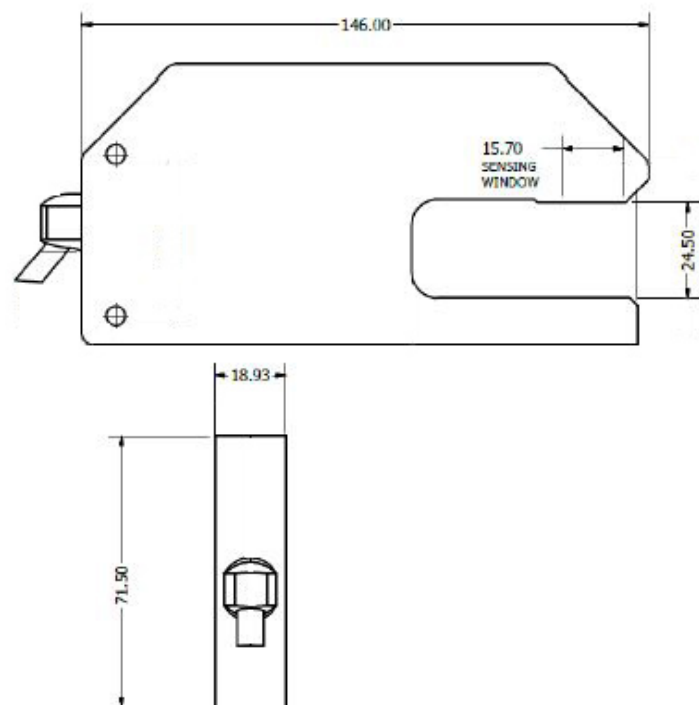
Quick Facts

MODEL	APPLICATION
LPA56B	Automatic Machine
Voltage Supply	24VDC @ 200 mA +/- 10%
Discrete Inputs (2)	24VDC
Electro-Mechanical Output (2)	24 VDC @ 0.5A - dry contact
Serial Communication	RS232
LASER	
Wavelength Class	658 nm 2M
DYNAMIC PERFORMANCE	
Inspection Window Length	16 mm (0.63")
Resolution - Length Resolution - Width	0.12 mm (0.047") 0.192 mm @ 10meters/second 0.038 mm @ 2 meters/second
Wire Speed Range	0.5 - 14 Meters / second
WIRE & SEAL SIZE	
Typical Wire Size	1.31 mm ² – 0.05 mm ² (16 – 30 AWG)
Seal Diameter Range	2-10 mm (0.079" - 0.390")
PHYSICAL	
Dimensions	18.93 x 146 x 71.5mm 0.75" x 5.75" x 2.81

WireScan LPA56B

The WireScan B-Series Laser Profile Analyzer is a compact optical sensor for strip and seal inspection. The unit projects a 16mm sensing window. As the wire passes through the sensing window, an image of the wire is captured with a resolution of 0.12 mm.

Using OES's proven algorithms, the image profile of each wire sample is compared with the "learned" standard profile image and a determination is made if the part is a "pass" or "fail".



About OES Technologies



OES Technologies products and technologies are developed specifically for the wire processing industry to monitor and inspect 100% of parts produced during the manufacturing process, and prevent part defects from entering the supply chain. OES's dedication to innovation enables them to deliver a steady stream of cutting-edge technologies that meet the exacting demands of this ever-changing market.